

Lead (Pb)-Free Thick Film, Rectangular, Semi-Precision Chip Resistors



FEATURES

- Low temperature coefficient (50 ppm/K) and tight tolerances ($\pm 0.25\%$)
- Pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processing
- Metal glaze on high quality ceramic
- AEC-Q200 qualified
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

| STANDARD ELECTRICAL SPECIFICATIONS | | | | | | | | |
|------------------------------------|----------------|------------------|-------------------------|---|-------------------------------|----------------------------|---------------------------|----------|
| MODEL | CASE SIZE INCH | CASE SIZE METRIC | POWER RATING P_{70} W | LIMITING ELEMENT VOLTAGE $U_{max. AC_{RMS}/DC}$ V | TEMPERATURE COEFFICIENT ppm/K | TOLERANCE % | RESISTANCE RANGE Ω | SERIES |
| D10/CRCW0402-P | 0402 | 1005 | 0.063 | 50 | ± 100 | ± 0.5 | 1R to 1M1 | E24; E96 |
| | | | | | ± 50 | $\pm 0.25, \pm 0.5, \pm 1$ | 100R to 1M | |
| D11/CRCW0603-P | 0603 | 1608 | 0.1 | 75 | ± 100 | $\pm 0.5, \pm 0.25$ | 1R to 10M | E24; E96 |
| | | | | | ± 50 | ± 0.25 | 100R to 1M | |
| D12/CRCW0805-P | 0805 | 2012 | 0.125 | 150 | ± 100 | ± 0.5 | 10R to 10M | E24; E96 |
| | | | | | ± 50 | ± 0.25 | 100R to 1M | |
| D25/CRCW1206-P | 1206 | 3216 | 0.25 | 200 | ± 100 | ± 0.5 | 10R to 10M | E24; E96 |
| | | | | | ± 50 | ± 0.25 | 100R to 1M | |
| CRCW1210-P | 1210 | 3225 | 0.5 | 200 | ± 100 | ± 0.5 | 100R to 1M | E24; E96 |
| | | | | | ± 50 | $\pm 0.5, \pm 1$ | 100R to 1M | |
| CRCW1218-P | 1218 | 3246 | 1.0 | 200 | ± 100 | ± 0.5 | 100R to 2M2 | E24; E96 |
| | | | | | ± 50 | $\pm 0.5, \pm 1$ | 100R to 2M2 | |
| CRCW2010-P | 2010 | 5025 | 0.75 | 400 | ± 100 | ± 0.5 | 10R to 10M | E24; E96 |
| | | | | | ± 50 | $\pm 0.5, \pm 1$ | 100R to 10M | |
| CRCW2512-P | 2512 | 6332 | 1.0 | 500 | ± 100 | ± 0.5 | 10R to 10M | E24; E96 |
| | | | | | ± 50 | $\pm 0.5, \pm 1$ | 100R to 10M | |

Notes

- These resistors do not feature a limited lifetime when operated within the limits of rated dissipation, permissible operating voltage and permissible film temperature. However, the resistance typically increase due to the resistor's film temperature over operating time generally known as drift. The drift may exceed the stability requirements of an individual application circuit and thereby limits the functional time.
- Marking and packaging: See datasheet "Surface Mount Resistor Marking" (www.vishay.com/doc?20020).
- Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.



| TECHNICAL SPECIFICATIONS | | | | | | | | | |
|--|-----------------|--------------------------|--------------------|--------------------|--------------------|------------|------------|------------|------------|
| PARAMETER | UNIT | D10/ CRCW0402-P | D11/ CRCW0603-P | D12/ CRCW0805-P | D25/ CRCW1206-P | CRCW1210-P | CRCW1218-P | CRCW2010-P | CRCW2512-P |
| Rated Dissipation at P_{70} ⁽¹⁾ | W | 0.063 | 0.1 | 0.125 | 0.25 | 0.5 | 1.0 | 0.75 | 1.0 |
| Operating Voltage U_{max} , AC _{RMS} /DC | V | 50 | 75 | 150 | 200 | 200 | 200 | 400 | 500 |
| Insulation Voltage U_{ins} (1 min) | V | 75 | 100 | 200 | 300 | 300 | 300 | 300 | 300 |
| Insulation Resistance | Ω | > 10 ⁹ | | | | | | | |
| Operating Temperature Range | °C | - 55 to + 155 | | | | | | | |
| Failure Rate | h ⁻¹ | < 0.1 x 10 ⁻⁹ | | | | | | | |
| Weight | mg | 0.65 | 2 | 5.5 | 10 | 16 | 29.5 | 25.5 | 40.5 |

Note

⁽¹⁾ The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

| PART NUMBER AND PRODUCT DESCRIPTION | | | | | | | | | | | | | | | | |
|--|---|--|---|--|---|-----------------------------------|---|---|---|--|---|---|---|---|---|---|
| PART NUMBER: CRCW040275R0DKEDP | | | | | | | | | | | | | | | | |
| C | R | C | W | 0 | 4 | 0 | 2 | 7 | 5 | R | 0 | D | K | E | D | P |
| MODEL | | RESISTANCE | | TOLERANCE | | TCR | | PACKAGING | | SPECIAL | | | | | | |
| CRCW0402 CRCW0603 CRCW0805 CRCW1206 CRCW1210 CRCW1218 CRCW2010 CRCW2512 | | R = Decimal K = Thousand M = Million | | C = ± 0.25 % D = ± 0.5 % F = ± 1.0 % | | H = ± 50 ppm/K K = ± 100 ppm/K | | EA, EB, EC, ED, EE, EF, EG, EH, EI, EL EK | | P = Semi-Precision | | | | | | |
| PRODUCT DESCRIPTION: D10/CRCW0402-P 100 75R 0.5 % ET7 e3 | | | | | | | | | | | | | | | | |
| D10/CRCW0402-P | | 100 | | 75R | | 0.5 % | | ET7 | | e3 | | | | | | |
| MODEL | | TCR | | RESISTANCE | | TOLERANCE | | PACKAGING | | LEAD (Pb)-FREE | | | | | | |
| D10/CRCW0402-P D11/CRCW0603-P D12/CRCW0805-P D25/CRCW1206-P CRCW1210-P CRCW1218-P CRCW2010-P CRCW2512-P | | ± 50 ppm/K ± 100 ppm/K | | 49K9 = 49.9 kΩ 5R1 = 5.1 Ω | | ± 0.25 % ± 0.5 % ± 1 % | | ET1, ET2, ET3, ET4, ET5, ET6, ET7, ET8, ET9, EF4, E02, E67, E82 | | e3 = Pure tin termination finish | | | | | | |

| PACKAGING | | | | | | |
|----------------|----------|---------------|--|-------|---------------|---------------|
| MODEL | CODE | QUANTITY | CARRIER TAPE | WIDTH | PITCH | REEL DIAMETER |
| D10/CRCW0402-P | ED = ET7 | 10 000 | Paper tape acc. to IEC 60068-3 Type I | 8 mm | 2 mm | 180 mm/7" |
| | EE = EF4 | 50 000 | | | | 330 mm/13" |
| D11/CRCW0603-P | EI = ET2 | 5000 | | 8 mm | 2 mm | 180 mm/7" |
| | ED = ET3 | 10 000 | | | | 180 mm/7" |
| | EL = ET4 | 20 000 | | | | 285 mm/11.25" |
| | EE = ET8 | 50 000 | | | | 330 mm/13" |
| | EA = ET1 | 5000 | | | | 8 mm |
| EB = ET5 | 10 000 | 285 mm/11.25" | | | | |
| EC = ET6 | 20 000 | 330 mm/13" | | | | |
| D12/CRCW0805-P | EA = ET1 | 5000 | | 8 mm | 4 mm | 180 mm/7" |
| | EB = ET5 | 10 000 | 285 mm/11.25" | | | |
| | EC = ET6 | 20 000 | 330 mm/13" | | | |
| D25/CRCW1206-P | EA = ET1 | 5000 | 8 mm | 4 mm | 180 mm/7" | |
| | EB = ET5 | 10 000 | | | 285 mm/11.25" | |
| | EC = ET6 | 20 000 | | | 330 mm/13" | |
| CRCW1210-P | EA = ET1 | 5000 | 12 mm | 4 mm | 180 mm/7" | |
| | EB = ET5 | 10 000 | | | 285 mm/11.25" | |
| | EC = ET6 | 20 000 | | | 330 mm/13" | |
| CRCW1218-P | EK = ET9 | 4000 | Blister tape acc. to IEC 60068-3 Type II | 12 mm | 4 mm | 180 mm/7" |
| CRCW2010-P | EF = E02 | 4000 | | 12 mm | 4 mm | 180 mm/7" |
| CRCW2512-P | EG = E67 | 2000 | | 12 mm | 8 mm | 180 mm/7" |
| | EH = E82 | 4000 | 4 mm | | 180 mm/7" | |

| DIMENSIONS in millimeters | | | | | | | | | | | | |
|---------------------------|--------|--|-------------|-------------|---------------------------------------|-----------|-----------------------|-----|-----|----------------|-----|-----|
| | | | | | | | | | | | | |
| SIZE | | DIMENSIONS | | | | | SOLDER PAD DIMENSIONS | | | | | |
| INCH | METRIC | L | W | H | T1 | T2 | REFLOW SOLDERING | | | WAVE SOLDERING | | |
| | | | | | | | a | b | l | a | b | l |
| 0402 | 1005 | 1.0 ± 0.05 | 0.5 ± 0.05 | 0.35 ± 0.05 | 0.25 ± 0.05 | 0.2 ± 0.1 | 0.4 | 0.6 | 0.5 | | | |
| 0603 | 1608 | 1.55 ^{+0.10} _{-0.05} | 0.85 ± 0.1 | 0.45 ± 0.05 | 0.3 ± 0.2 | 0.3 ± 0.2 | 0.5 | 0.9 | 1.0 | 0.9 | 0.9 | 1.0 |
| 0805 | 2012 | 2.0 ^{+0.20} _{-0.10} | 1.25 ± 0.15 | 0.45 ± 0.05 | 0.3 ^{+0.20} _{-0.10} | 0.3 ± 0.2 | 0.7 | 1.3 | 1.2 | 0.9 | 1.3 | 1.3 |
| 1206 | 3216 | 3.2 ^{+0.10} _{-0.20} | 1.6 ± 0.15 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 0.9 | 1.7 | 2.0 | 1.1 | 1.7 | 2.3 |
| 1210 | 3225 | 3.2 ± 0.2 | 2.5 ± 0.2 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 0.9 | 2.5 | 2.0 | 1.1 | 2.5 | 2.2 |
| 1218 | 3246 | 3.2 ^{+0.10} _{-0.20} | 4.6 ± 0.15 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 1.05 | 4.9 | 1.9 | 1.25 | 4.8 | 1.9 |
| 2010 | 5025 | 5.0 ± 0.15 | 2.5 ± 0.15 | 0.6 ± 0.1 | 0.6 ± 0.2 | 0.6 ± 0.2 | 1.0 | 2.5 | 3.9 | 1.2 | 2.5 | 3.9 |
| 2512 | 6332 | 6.3 ± 0.2 | 3.15 ± 0.15 | 0.6 ± 0.1 | 0.6 ± 0.2 | 0.6 ± 0.2 | 1.0 | 3.2 | 5.2 | 1.2 | 3.2 | 5.2 |

FUNCTIONAL PERFORMANCE


| TEST PROCEDURES AND REQUIREMENTS | | | | |
|----------------------------------|-------------------------|-----------------------------|---|---|
| EN 60115-1 CLAUSE | IEC 60068-2 TEST METHOD | TEST | PROCEDURE | REQUIREMENTS PERMISSIBLE CHANGE (ΔR) |
| | | | Stability for product types: | STABILITY CLASS 1 OR BETTER |
| | | | D/CRCW-P e3 | 1 Ω to 10 M Ω |
| 4.5 | - | Resistance | - | $\pm 0.25\%$; $\pm 0.5\%$; $\pm 1\%$ |
| 4.7 | - | Voltage proof | $U = 1.4 \times U_{ins}$; 60 s | No flashover or breakdown |
| 4.13 | - | Short time overload | $U = 2.5 \times \sqrt{P_{70} \times R} \leq 2 \times U_{max.}$; duration acc. to style | $\pm (0.25\% R + 0.05 \Omega)$ |
| 4.17.2 | 58 (Td) | Solderability | Solder bath method; Sn60Pb40 non-activated flux; (235 \pm 5) °C (2 \pm 0.2) s | Good tinning ($\geq 95\%$ covered) no visible damage |
| | | | Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; (245 \pm 5) °C (3 \pm 0.3) s | Good tinning ($\geq 95\%$ covered) no visible damage |
| 4.8.4.2 | - | Temperature coefficient | (20/- 55/20) °C and (20/125/20) °C | ± 50 ppm/K; ± 100 ppm/K |
| 4.32 | 21 (Uu ₃) | Shear (adhesion) | RR 1608 and smaller: 9 N RR 2012 and larger: 45 N | No visible damage |
| 4.33 | 21 (Uu ₁) | Substrate bending | Depth 2 mm; 3 times | No visible damage, no open circuit in bent position $\pm (0.25\% R + 0.05 \Omega)$ |
| 4.19 | 14 (Na) | Rapid change of temperature | 30 min at - 55 °C; 30 min at 125 °C 5 cycles 1000 cycles | $\pm (0.25\% R + 0.05 \Omega)$ $\pm (1\% R + 0.05 \Omega)$ |



| TEST PROCEDURES AND REQUIREMENTS | | | | |
|----------------------------------|-------------------------|--|---|---|
| EN 60115-1 CLAUSE | IEC 60068-2 TEST METHOD | TEST | PROCEDURE | REQUIREMENTS PERMISSIBLE CHANGE (ΔR) |
| | | | Stability for product types: | STABILITY CLASS 1 OR BETTER 1 Ω to 10 M Ω |
| | | | D/CRCW-P e3 | |
| 4.23 | - | Climatic sequence: | - | $\pm (1 \% R + 0.05 \Omega)$ |
| 4.23.2 | 2 (Ba) | Dry heat | 125 °C; 16 h | |
| 4.23.3 | 30 (Db) | Damp heat, cyclic | 55 °C; $\geq 90 \% RH$; 24 h; 1 cycle | |
| 4.23.4 | 1 (Aa) | Cold | - 55 °C; 2 h | |
| 4.23.5 | 13 (M) | Low air pressure | 1 kPa; (25 \pm 10) °C; 1 h | |
| 4.23.6 | 30 (Db) | Damp heat, cyclic | 55 °C; $\geq 90 \% RH$; 24 h; 5 cycles | |
| 4.23.7 | - | DC load | $U = \sqrt{P_{70} \times R}$ | |
| 4.25.1 | - | Endurance at 70 °C | $U = \sqrt{P_{70} \times R} \leq U_{max.}$; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h | $\pm (1 \% R + 0.05 \Omega)$ $\pm (2 \% R + 0.05 \Omega)$ |
| 4.18.2 | 58 (Td) | Resistance to soldering heat | Solder bath method (260 \pm 5) °C; (10 \pm 1) s | $\pm (0.25 \% R + 0.05 \Omega)$ |
| 4.35 | - | Flamability, needle flame test | IEC 60695-11-5; 10 s | No burning after 30 s |
| 4.24 | 78 (Cab) | Damp heat, steady state | (40 \pm 2) °C; (93 \pm 3) % RH; 56 days | $\pm (1 \% R + 0.05 \Omega)$ |
| 4.25.3 | - | Endurance at upper category temperature | 155 °C, 1000 h | $\pm (1 \% R + 0.05 \Omega)$ |
| 4.40 | - | Electrostatic discharge (human body model) | IEC 61340-3-1; 3 pos. + 3 neg. discharges; ESD voltage acc. to size | $\pm (1 \% R + 0.05 \Omega)$ |
| 4.29 | 45 (XA) | Component solvent resistance | Isopropyl alcohol; 50 °C; method 2 | No visible damage |
| 4.30 | 45 (XA) | Solvent resistance of marking | Isopropyl alcohol; 50 °C; method 1, toothbrush | Marking legible, no visible damage |
| 4.22 | 6 (Fc) | Vibration, endurance by sweeping | f = 10 Hz to 2000 Hz; x, y, z \leq 1.5 mm; A \leq 200 m/s ² ; 10 sweeps per axis | $\pm (0.25 \% R + 0.05 \Omega)$ |
| 4.37 | - | Periodic electric overload | $U = \sqrt{15 \times P_{70} \times R}$ $\leq 2 \times U_{max.}$; 0.1 s on; 2.5 s off; 1000 cycles | $\pm (1 \% R + 0.05 \Omega)$ |
| 4.27 | - | Single pulse high voltage overload, 10 μ s/700 μ s | $\hat{U} = 10 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{max.}$; 10 pulses | $\pm (1 \% R + 0.05 \Omega)$ |

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x, variety of environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3.



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.